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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Active
Number of LABs/CLBs	1591
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/4	737
Number of Gates	756555
Voltage - Supply	0.0~V 2 ~.0~V
Mounting Type	Surface Mount
Operating Temperature	50C 2 350C (TA)
Package / Case	056-BF° FP
Supplier Device Package	056-P° FP (06x06)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a-j_sx30a-pqg056">https://www.e-xfl.com/product-detail/microchip-technology/a-j_sx30a-pqg056</a>

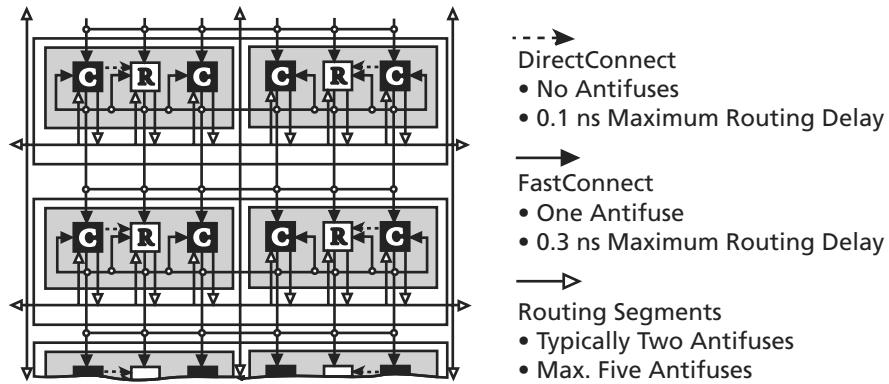


Figure 1-5 • DirectConnect and FastConnect for Type 1 SuperClusters

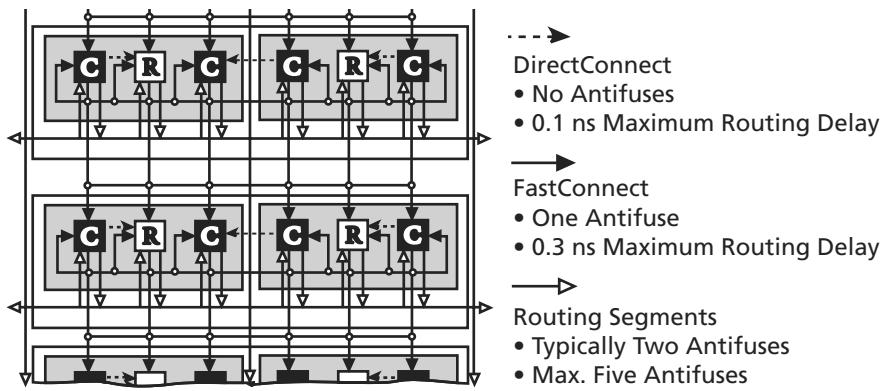


Figure 1-6 • DirectConnect and FastConnect for Type 2 SuperClusters

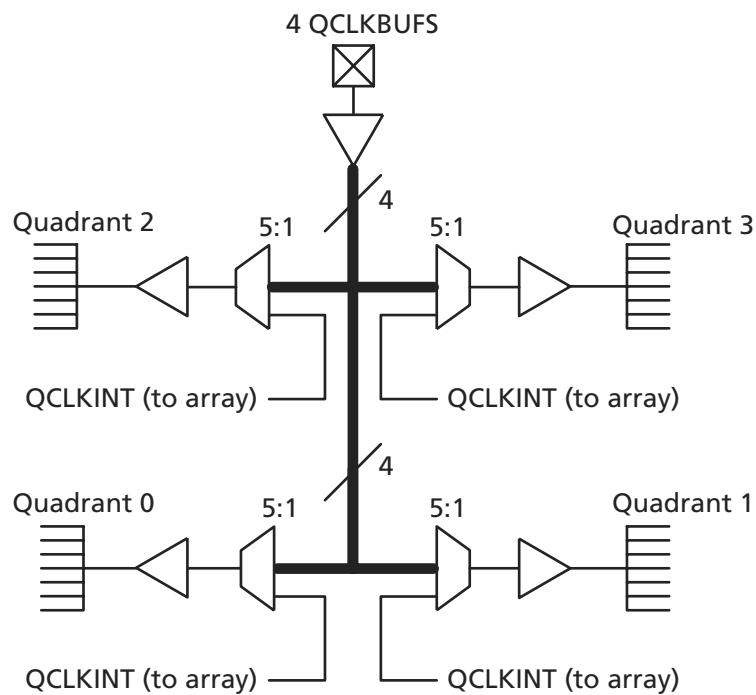


Figure 1-9 • SX-A QCLK Architecture

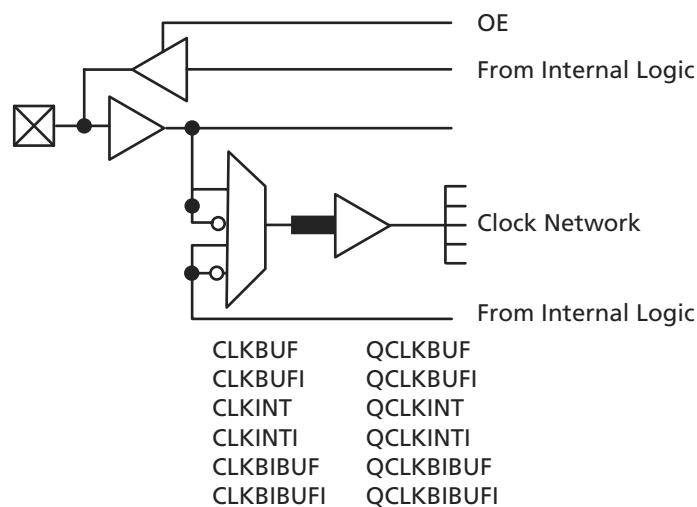


Figure 1-10 • A54SX72A Routed Clock and QCLK Buffer

## SX-A Probe Circuit Control Pins

SX-A devices contain internal probing circuitry that provides built-in access to every node in a design, enabling 100% real-time observation and analysis of a device's internal logic nodes without design iteration. The probe circuitry is accessed by Silicon Explorer II, an easy to use, integrated verification and logic analysis tool that can sample data at 100 MHz (asynchronous) or 66 MHz (synchronous). Silicon Explorer II attaches to a PC's standard COM port, turning the PC into a fully functional 18-channel logic analyzer. Silicon Explorer II allows designers to complete the design verification process at their desks and reduces verification time from several hours per cycle to a few seconds.

The Silicon Explorer II tool uses the boundary-scan ports (TDI, TCK, TMS, and TDO) to select the desired nets for verification. The selected internal nets are assigned to the

PRA/PRB pins for observation. Figure 1-13 illustrates the interconnection between Silicon Explorer II and the FPGA to perform in-circuit verification.

## Design Considerations

In order to preserve device probing capabilities, users should avoid using the TDI, TCK, TDO, PRA, and PRB pins as input or bidirectional ports. Since these pins are active during probing, critical input signals through these pins are not available. In addition, the security fuse must not be programmed to preserve probing capabilities. Actel recommends that you use a  $70\ \Omega$  series termination resistor on every probe connector (TDI, TCK, TMS, TDO, PRA, PRB). The  $70\ \Omega$  series termination is used to prevent data transmission corruption during probing and reading back the checksum.

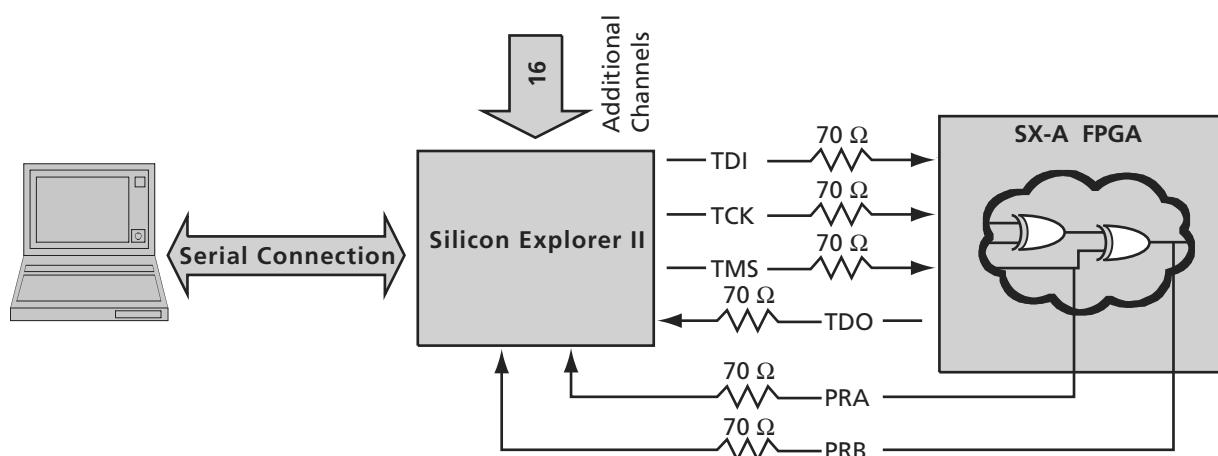


Figure 1-13 • Probe Setup

# Detailed Specifications

## Operating Conditions

Table 2-1 • Absolute Maximum Ratings

Symbol	Parameter	Limits	Units
$V_{CCI}$	DC Supply Voltage for I/Os	-0.3 to +6.0	V
$V_{CCA}$	DC Supply Voltage for Arrays	-0.3 to +3.0	V
$V_I$	Input Voltage	-0.5 to +5.75	V
$V_O$	Output Voltage	-0.5 to + $V_{CCI}$ + 0.5	V
$T_{STG}$	Storage Temperature	-65 to +150	°C

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the "Recommended Operating Conditions".

Table 2-2 • Recommended Operating Conditions

Parameter	Commercial	Industrial	Units
Temperature Range	0 to +70	-40 to +85	°C
2.5 V Power Supply Range ( $V_{CCA}$ and $V_{CCI}$ )	2.25 to 2.75	2.25 to 2.75	V
3.3 V Power Supply Range ( $V_{CCI}$ )	3.0 to 3.6	3.0 to 3.6	V
5 V Power Supply Range ( $V_{CCI}$ )	4.75 to 5.25	4.75 to 5.25	V

## Typical SX-A Standby Current

Table 2-3 • Typical Standby Current for SX-A at 25°C with  $V_{CCA} = 2.5$  V

Product	$V_{CCI} = 2.5$ V	$V_{CCI} = 3.3$ V	$V_{CCI} = 5$ V
A54SX08A	0.8 mA	1.0 mA	2.9 mA
A54SX16A	0.8 mA	1.0 mA	2.9 mA
A54SX32A	0.9 mA	1.0 mA	3.0 mA
A54SX72A	3.6 mA	3.8 mA	4.5 mA

Table 2-4 • Supply Voltages

$V_{CCA}$	$V_{CCI}^*$	Maximum Input Tolerance	Maximum Output Drive
2.5 V	2.5 V	5.75 V	2.7 V
2.5 V	3.3 V	5.75 V	3.6 V
2.5 V	5 V	5.75 V	5.25 V

**Note:** \*3.3 V PCI is not 5 V tolerant due to the clamp diode, but instead is 3.3 V tolerant.

Table 2-10 • AC Specifications (3.3 V PCI Operation)

Symbol	Parameter	Condition	Min.	Max.	Units
$I_{OH(AC)}$	Switching Current High	$0 < V_{OUT} \leq 0.3V_{CCI}$ <sup>1</sup>	-12 $V_{CCI}$	–	mA
		$0.3V_{CCI} \leq V_{OUT} < 0.9V_{CCI}$ <sup>1</sup>	(-17.1( $V_{CCI} - V_{OUT}$ ))	–	mA
		$0.7V_{CCI} < V_{OUT} < V_{CCI}$ <sup>1, 2</sup>	–	EQ 2-3 on page 2-7	–
	(Test Point)	$V_{OUT} = 0.7V_{CC}$ <sup>2</sup>	–	-32 $V_{CCI}$	mA
$I_{OL(AC)}$	Switching Current Low	$V_{CCI} > V_{OUT} \geq 0.6V_{CCI}$ <sup>1</sup>	16 $V_{CCI}$	–	mA
		$0.6V_{CCI} > V_{OUT} > 0.1V_{CCI}$ <sup>1</sup>	(26.7 $V_{OUT}$ )	–	mA
		$0.18V_{CCI} > V_{OUT} > 0$ <sup>1, 2</sup>	–	EQ 2-4 on page 2-7	–
	(Test Point)	$V_{OUT} = 0.18V_{CC}$ <sup>2</sup>	–	38 $V_{CCI}$	mA
$I_{CL}$	Low Clamp Current	$-3 < V_{IN} \leq -1$	$-25 + (V_{IN} + 1)/0.015$	–	mA
$I_{CH}$	High Clamp Current	$V_{CCI} + 4 > V_{IN} \geq V_{CCI} + 1$	$25 + (V_{IN} - V_{CCI} - 1)/0.015$	–	mA
$slew_R$	Output Rise Slew Rate	$0.2V_{CCI} - 0.6V_{CCI}$ load <sup>3</sup>	1	4	V/ns
$slew_F$	Output Fall Slew Rate	$0.6V_{CCI} - 0.2V_{CCI}$ load <sup>3</sup>	1	4	V/ns

**Notes:**

- Refer to the  $V/I$  curves in Figure 2-2 on page 2-7. Switching current characteristics for REQ# and GNT# are permitted to be one half of that specified here; i.e., half size output drivers may be used on these signals. This specification does not apply to CLK and RST#, which are system outputs. "Switching Current High" specifications are not relevant to SERR#, INTA#, INTB#, INTC#, and INTD#, which are open drain outputs.
- Maximum current requirements must be met as drivers pull beyond the last step voltage. Equations defining these maximums (C and D) are provided with the respective diagrams in Figure 2-2 on page 2-7. The equation defined maximum should be met by design. In order to facilitate component testing, a maximum current test point is defined for each side of the output driver.
- This parameter is to be interpreted as the cumulative edge rate across the specified range, rather than the instantaneous rate at any point within the transition range. The specified load (diagram below) is optional; i.e., the designer may elect to meet this parameter with an unloaded output per the latest revision of the PCI Local Bus Specification. However, adherence to both maximum and minimum parameters is required (the maximum is no longer simply a guideline). Rise slew rate does not apply to open drain outputs.

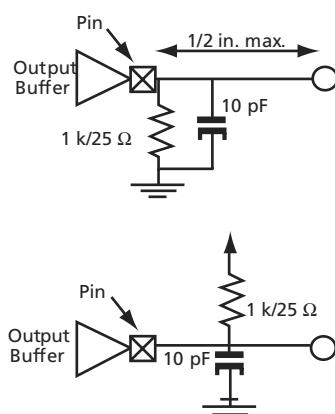


Figure 2-2 shows the 3.3 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the SX-A family.

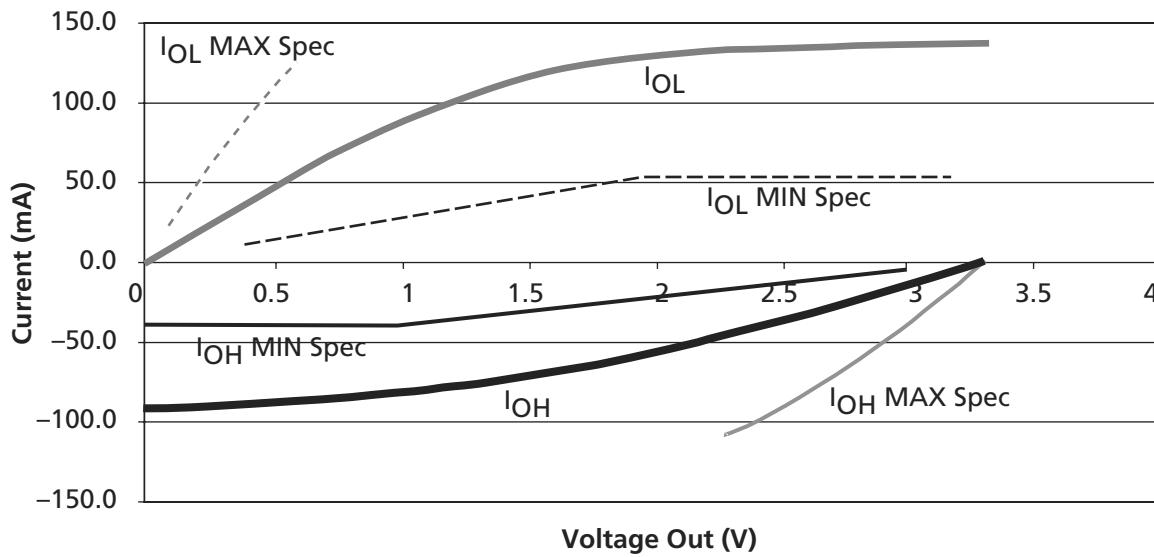


Figure 2-2 • 3.3 V PCI V/I Curve for SX-A Family

$$I_{OH} = (98.0V_{CCI}) * (V_{OUT} - V_{CCI}) * (V_{OUT} + 0.4V_{CCI})$$

for  $0.7V_{CCI} < V_{OUT} < V_{CCI}$

EQ 2-3

$$I_{OL} = (256V_{CCI}) * V_{OUT} * (V_{CCI} - V_{OUT})$$

for  $0V < V_{OUT} < 0.18V_{CCI}$

EQ 2-4

## Input Buffer Delays

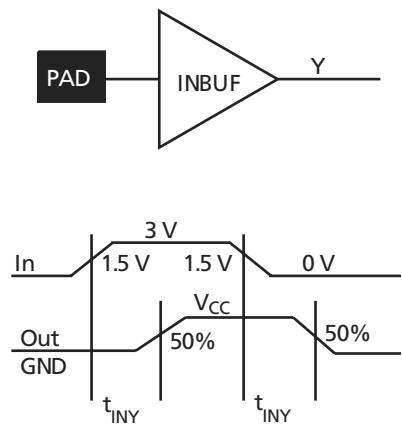


Figure 2-6 • Input Buffer Delays

## C-Cell Delays

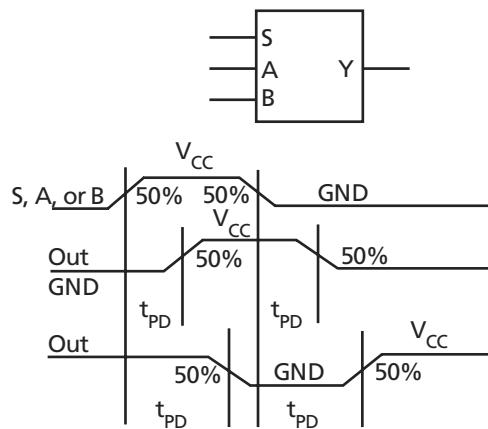


Figure 2-7 • C-Cell Delays

## Cell Timing Characteristics

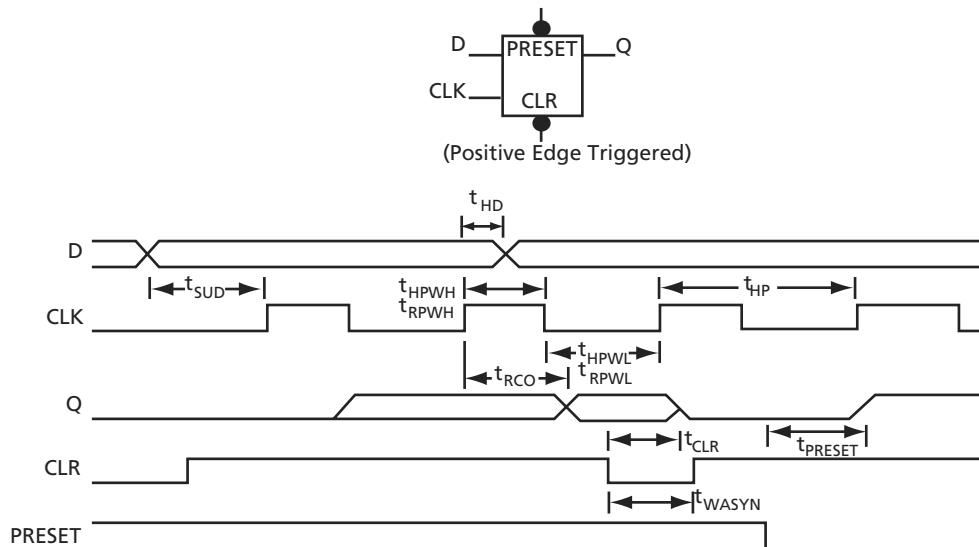


Figure 2-8 • Flip-Flops

Table 2-22 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.2	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.7	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.6	2.2	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-32 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	
<b>2.5 V LVC MOS Output Module Timing<sup>2,3</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.3	3.8	4.2	5.0	7.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.2	3.8	5.3	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	11.1	12.8	14.5	17.0	23.8	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.4	2.8	3.2	3.7	5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	11.8	13.7	15.5	18.2	25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.3	3.8	4.2	5.0	7.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.1	2.5	2.8	3.3	4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.2	3.8	5.3	ns
$d_{TLH}^4$	Delta Low to High	0.031	0.037	0.043	0.051	0.071	ns/pF
$d_{THL}^4$	Delta High to Low	0.017	0.017	0.023	0.023	0.037	ns/pF
$d_{THLS}^4$	Delta High to Low—low slew	0.057	0.06	0.071	0.086	0.117	ns/pF

**Note:**

1. All -3 speed grades have been discontinued.
2. Delays based on 35 pF loading.
3. The equivalent IO Attribute settings for 2.5 V LVC MOS is 2.5 V LVTTL in the software.
4. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-34 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>5 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.1	2.4	2.8	3.2	4.5	ns
$t_{DHL}$	Data-to-Pad High to Low	2.8	3.2	3.6	4.2	5.9	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.3	1.5	1.7	2.0	2.8	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.1	2.4	2.8	3.2	4.5	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.0	3.5	3.9	4.6	6.4	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.8	3.2	3.6	4.2	5.9	ns
$d_{TLH}^3$	Delta Low to High	0.016	0.016	0.02	0.022	0.032	ns/pF
$d_{THL}^3$	Delta High to Low	0.026	0.03	0.032	0.04	0.052	ns/pF
<b>5 V TTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	1.9	2.2	2.5	2.9	4.1	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.3	3.9	5.4	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	6.6	7.6	8.6	10.1	14.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.1	2.4	2.7	3.2	4.5	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	7.4	8.4	9.5	11.0	15.4	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	1.9	2.2	2.5	2.9	4.1	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.6	4.2	4.7	5.6	7.8	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.3	3.9	5.4	ns
$d_{TLH}^3$	Delta Low to High	0.014	0.017	0.017	0.023	0.031	ns/pF
$d_{THL}^3$	Delta High to Low	0.023	0.029	0.031	0.037	0.051	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.043	0.046	0.057	0.066	0.089	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 50 pF loading.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$

where  $C_{load}$  is the load capacitance driven by the I/O in pF

$d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

Table 2-37 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.7	1.9	2.2	2.5	3.5	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.7	2	2.2	2.6	3.6	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-38 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.5	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-39 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>2.5 V LVC MOS Output Module Timing<sup>2, 3</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.9	4.5	5.1	6.0	8.4	ns
$t_{DHL}$	Data-to-Pad High to Low	3.1	3.6	4.1	4.8	6.7	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	12.7	14.6	16.5	19.4	27.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.4	2.8	3.2	3.7	5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	11.8	13.7	15.5	18.2	25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.9	4.5	5.1	6.0	8.4	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.1	2.5	2.8	3.3	4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.1	3.6	4.1	4.8	6.7	ns
$d_{TLH}^4$	Delta Low to High	0.031	0.037	0.043	0.051	0.071	ns/pF
$d_{THL}^4$	Delta High to Low	0.017	0.017	0.023	0.023	0.037	ns/pF
$d_{THLS}^4$	Delta High to Low—low slew	0.057	0.06	0.071	0.086	0.117	ns/pF

**Note:**

1. All -3 speed grades have been discontinued.
2. Delays based on 35 pF loading.
3. The equivalent IO Attribute settings for 2.5 V LVC MOS is 2.5 V LVTTL in the software.
4. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-40 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>3.3 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.3	2.7	3.0	3.6	5.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.2	3.8	5.3	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.4	1.7	1.9	2.2	3.1	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.3	2.7	3.0	3.6	5.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.2	3.8	5.3	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.2	3.8	5.3	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
<b>3.3 V LVTTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.2	3.7	4.2	5.0	6.9	ns
$t_{DHL}$	Data-to-Pad High to Low	3.2	3.7	4.2	4.9	6.9	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	10.3	11.9	13.5	15.8	22.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.2	2.6	2.9	3.4	4.8	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	15.8	18.9	21.3	25.4	34.9	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.2	3.7	4.2	5.0	6.9	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.9	3.3	3.7	4.4	6.2	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.2	3.7	4.2	4.9	6.9	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.053	0.053	0.067	0.073	0.107	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 10 pF loading and 25  $\Omega$  resistance.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
71	I/O	I/O	I/O	I/O
72	I/O	I/O	I/O	I/O
73	NC	I/O	I/O	I/O
74	I/O	I/O	I/O	QCLKA
75	NC	I/O	I/O	I/O
76	PRB, I/O	PRB, I/O	PRB, I/O	PRB, I/O
77	GND	GND	GND	GND
78	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
79	GND	GND	GND	GND
80	NC	NC	NC	NC
81	I/O	I/O	I/O	I/O
82	HCLK	HCLK	HCLK	HCLK
83	I/O	I/O	I/O	V <sub>CCI</sub>
84	I/O	I/O	I/O	QCLKB
85	NC	I/O	I/O	I/O
86	I/O	I/O	I/O	I/O
87	I/O	I/O	I/O	I/O
88	NC	I/O	I/O	I/O
89	I/O	I/O	I/O	I/O
90	I/O	I/O	I/O	I/O
91	NC	I/O	I/O	I/O
92	I/O	I/O	I/O	I/O
93	I/O	I/O	I/O	I/O
94	NC	I/O	I/O	I/O
95	I/O	I/O	I/O	I/O
96	I/O	I/O	I/O	I/O
97	NC	I/O	I/O	I/O
98	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
99	I/O	I/O	I/O	I/O
100	I/O	I/O	I/O	I/O
101	I/O	I/O	I/O	I/O
102	I/O	I/O	I/O	I/O
103	TDO, I/O	TDO, I/O	TDO, I/O	TDO, I/O
104	I/O	I/O	I/O	I/O
105	GND	GND	GND	GND

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
106	NC	I/O	I/O	I/O
107	I/O	I/O	I/O	I/O
108	NC	I/O	I/O	I/O
109	I/O	I/O	I/O	I/O
110	I/O	I/O	I/O	I/O
111	I/O	I/O	I/O	I/O
112	I/O	I/O	I/O	I/O
113	I/O	I/O	I/O	I/O
114	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
115	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
116	NC	I/O	I/O	GND
117	I/O	I/O	I/O	V <sub>CCA</sub>
118	I/O	I/O	I/O	I/O
119	NC	I/O	I/O	I/O
120	I/O	I/O	I/O	I/O
121	I/O	I/O	I/O	I/O
122	NC	I/O	I/O	I/O
123	I/O	I/O	I/O	I/O
124	I/O	I/O	I/O	I/O
125	NC	I/O	I/O	I/O
126	I/O	I/O	I/O	I/O
127	I/O	I/O	I/O	I/O
128	I/O	I/O	I/O	I/O
129	GND	GND	GND	GND
130	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
131	GND	GND	GND	GND
132	NC	NC	NC	I/O
133	I/O	I/O	I/O	I/O
134	I/O	I/O	I/O	I/O
135	NC	I/O	I/O	I/O
136	I/O	I/O	I/O	I/O
137	I/O	I/O	I/O	I/O
138	NC	I/O	I/O	I/O
139	I/O	I/O	I/O	I/O
140	I/O	I/O	I/O	I/O

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
145	I/O
146	I/O
147	I/O
148	I/O
149	I/O
150	I/O
151	I/O
152	CLKA
153	CLKB
154	NC
155	GND
156	V <sub>CCA</sub>
157	PRA, I/O
158	I/O
159	I/O
160	I/O
161	I/O
162	I/O
163	I/O
164	I/O
165	I/O
166	I/O
167	I/O
168	I/O
169	V <sub>CCI</sub>
170	I/O
171	I/O
172	I/O
173	I/O
174	I/O
175	I/O
176	TCK, I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
D11	V <sub>CCA</sub>
D12	NC
D13	I/O
D14	I/O
D15	I/O
D16	I/O
D17	I/O
D18	I/O
D19	I/O
D20	I/O
D21	I/O
D22	I/O
D23	I/O
E1	V <sub>CCI</sub>
E2	I/O
E3	I/O
E4	I/O
E20	I/O
E21	I/O
E22	I/O
E23	I/O
F1	I/O
F2	TMS
F3	I/O
F4	I/O
F20	I/O
F21	I/O
F22	I/O
F23	I/O
G1	I/O
G2	I/O
G3	I/O
G4	I/O
G20	I/O
G21	I/O
G22	I/O
G23	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
H1	I/O
H2	I/O
H3	I/O
H4	I/O
H20	V <sub>CCA</sub>
H21	I/O
H22	I/O
H23	I/O
J1	NC
J2	I/O
J3	I/O
J4	I/O
J20	I/O
J21	I/O
J22	I/O
J23	I/O
K1	I/O
K2	I/O
K3	I/O
K4	I/O
K10	GND
K11	GND
K12	GND
K13	GND
K14	GND
K20	I/O
K21	I/O
K22	I/O
K23	I/O
L1	I/O
L2	I/O
L3	I/O
L4	NC
L10	GND
L11	GND
L12	GND
L13	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
L14	GND
L20	NC
L21	I/O
L22	I/O
L23	NC
M1	I/O
M2	I/O
M3	I/O
M4	V <sub>CCA</sub>
M10	GND
M11	GND
M12	GND
M13	GND
M14	GND
M20	V <sub>CCA</sub>
M21	I/O
M22	I/O
M23	V <sub>CCI</sub>
N1	I/O
N2	TRST, I/O
N3	I/O
N4	I/O
N10	GND
N11	GND
N12	GND
N13	GND
N14	GND
N20	NC
N21	I/O
N22	I/O
N23	I/O
P1	I/O
P2	I/O
P3	I/O
P4	I/O
P10	GND
P11	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
P12	GND
P13	GND
P14	GND
P20	I/O
P21	I/O
P22	I/O
P23	I/O
R1	I/O
R2	I/O
R3	I/O
R4	I/O
R20	I/O
R21	I/O
R22	I/O
R23	I/O
T1	I/O
T2	I/O
T3	I/O
T4	I/O
T20	I/O
T21	I/O
T22	I/O
T23	I/O
U1	I/O
U2	I/O
U3	V <sub>CCA</sub>
U4	I/O
U20	I/O
U21	V <sub>CCA</sub>
U22	I/O
U23	I/O
V1	V <sub>CCI</sub>
V2	I/O
V3	I/O
V4	I/O
V20	I/O
V21	I/O

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
A1	I/O	I/O	I/O
A2	I/O	I/O	I/O
A3	I/O	I/O	I/O
A4	I/O	I/O	I/O
A5	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
A6	GND	GND	GND
A7	CLKA	CLKA	CLKA
A8	I/O	I/O	I/O
A9	I/O	I/O	I/O
A10	I/O	I/O	I/O
A11	I/O	I/O	I/O
A12	I/O	I/O	I/O
B1	I/O	I/O	I/O
B2	GND	GND	GND
B3	I/O	I/O	I/O
B4	I/O	I/O	I/O
B5	I/O	I/O	I/O
B6	I/O	I/O	I/O
B7	CLKB	CLKB	CLKB
B8	I/O	I/O	I/O
B9	I/O	I/O	I/O
B10	I/O	I/O	I/O
B11	GND	GND	GND
B12	I/O	I/O	I/O
C1	I/O	I/O	I/O
C2	I/O	I/O	I/O
C3	TCK, I/O	TCK, I/O	TCK, I/O
C4	I/O	I/O	I/O
C5	I/O	I/O	I/O
C6	PRA, I/O	PRA, I/O	PRA, I/O
C7	I/O	I/O	I/O
C8	I/O	I/O	I/O
C9	I/O	I/O	I/O
C10	I/O	I/O	I/O
C11	I/O	I/O	I/O
C12	I/O	I/O	I/O

144-Pin FBGA			
Pin Number	A54SX08A Function	A54SX16A Function	A54SX32A Function
D1	I/O	I/O	I/O
D2	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
D3	TDI, I/O	TDI, I/O	TDI, I/O
D4	I/O	I/O	I/O
D5	I/O	I/O	I/O
D6	I/O	I/O	I/O
D7	I/O	I/O	I/O
D8	I/O	I/O	I/O
D9	I/O	I/O	I/O
D10	I/O	I/O	I/O
D11	I/O	I/O	I/O
D12	I/O	I/O	I/O
E1	I/O	I/O	I/O
E2	I/O	I/O	I/O
E3	I/O	I/O	I/O
E4	I/O	I/O	I/O
E5	TMS	TMS	TMS
E6	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E7	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
E9	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
E10	I/O	I/O	I/O
E11	GND	GND	GND
E12	I/O	I/O	I/O
F1	I/O	I/O	I/O
F2	I/O	I/O	I/O
F3	NC	NC	NC
F4	I/O	I/O	I/O
F5	GND	GND	GND
F6	GND	GND	GND
F7	GND	GND	GND
F8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
F9	I/O	I/O	I/O
F10	GND	GND	GND
F11	I/O	I/O	I/O
F12	I/O	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
A1	NC*	NC
A2	NC*	NC
A3	NC*	I/O
A4	NC*	I/O
A5	NC*	I/O
A6	I/O	I/O
A7	I/O	I/O
A8	I/O	I/O
A9	I/O	I/O
A10	I/O	I/O
A11	NC*	I/O
A12	NC*	I/O
A13	I/O	I/O
A14	NC*	NC
A15	NC*	I/O
A16	NC*	I/O
A17	I/O	I/O
A18	I/O	I/O
A19	I/O	I/O
A20	I/O	I/O
A21	NC*	I/O
A22	NC*	I/O
A23	NC*	I/O
A24	NC*	I/O
A25	NC*	NC
A26	NC*	NC
AA1	NC*	I/O
AA2	NC*	I/O
AA3	V <sub>CCA</sub>	V <sub>CCA</sub>
AA4	I/O	I/O
AA5	I/O	I/O
AA22	I/O	I/O
AA23	I/O	I/O
AA24	I/O	I/O
AA25	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AA26	NC*	I/O
AB1	NC*	NC
AB2	V <sub>CCI</sub>	V <sub>CCI</sub>
AB3	I/O	I/O
AB4	I/O	I/O
AB5	NC*	I/O
AB6	I/O	I/O
AB7	I/O	I/O
AB8	I/O	I/O
AB9	I/O	I/O
AB10	I/O	I/O
AB11	I/O	I/O
AB12	PRB, I/O	PRB, I/O
AB13	V <sub>CCA</sub>	V <sub>CCA</sub>
AB14	I/O	I/O
AB15	I/O	I/O
AB16	I/O	I/O
AB17	I/O	I/O
AB18	I/O	I/O
AB19	I/O	I/O
AB20	TDO, I/O	TDO, I/O
AB21	GND	GND
AB22	NC*	I/O
AB23	I/O	I/O
AB24	I/O	I/O
AB25	NC*	I/O
AB26	NC*	I/O
AC1	I/O	I/O
AC2	I/O	I/O
AC3	I/O	I/O
AC4	NC*	I/O
AC5	V <sub>CCI</sub>	V <sub>CCI</sub>
AC6	I/O	I/O
AC7	V <sub>CCI</sub>	V <sub>CCI</sub>
AC8	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
AC9	I/O	I/O
AC10	I/O	I/O
AC11	I/O	I/O
AC12	I/O	QCLKA
AC13	I/O	I/O
AC14	I/O	I/O
AC15	I/O	I/O
AC16	I/O	I/O
AC17	I/O	I/O
AC18	I/O	I/O
AC19	I/O	I/O
AC20	V <sub>CCI</sub>	V <sub>CCI</sub>
AC21	I/O	I/O
AC22	I/O	I/O
AC23	NC*	I/O
AC24	I/O	I/O
AC25	NC*	I/O
AC26	NC*	I/O
AD1	I/O	I/O
AD2	I/O	I/O
AD3	GND	GND
AD4	I/O	I/O
AD5	I/O	I/O
AD6	I/O	I/O
AD7	I/O	I/O
AD8	I/O	I/O
AD9	V <sub>CCI</sub>	V <sub>CCI</sub>
AD10	I/O	I/O
AD11	I/O	I/O
AD12	I/O	I/O
AD13	V <sub>CCI</sub>	V <sub>CCI</sub>
AD14	I/O	I/O
AD15	I/O	I/O
AD16	I/O	I/O
AD17	V <sub>CCI</sub>	V <sub>CCI</sub>

**Note:** \*These pins must be left floating on the A54SX32A device.

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